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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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MOS FET Relays

M-353B/B1/E/E1

Analog-switching MOS FET Relay with SPST-NC Contact. General-purpose Models Added.

- Switches minute AC and DC analog signals.
- General-purpose models (with high ON resistance) added.
- RoHS compliant

■ Application Examples

- Electronic automatic exchange systems
- · Security systems
- Datacom (modem) systems
- FA systems and Measurement devices





Note: The actual product is marked differently from the image shown here.

■ List of Models

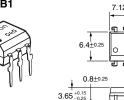
Contact form	Terminals	Load voltage (peak value)	Model	Number per stick	Number per tape
SPST-NC	PCB terminals	350 VAC	G3VM-353B	50	
			G3VM-353B1		
	Surface-mounting terminals		G3VM-353E		
			G3VM-353E1		
			G3VM-353E(TR)		1,500
			G3VM-353E1(TR)		

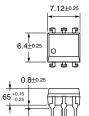
■ Dimensions

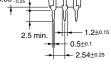
Note: All units are in millimeters unless otherwise indicated.



Note: The actual product is marked different-



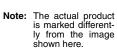


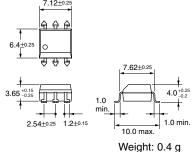


7.62±0.25 -0.25^{+0.1}_{-0.05} 7.85 to 8.80 Weight: 0.4 g



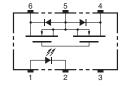
G3VM-353E/E1





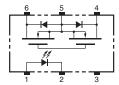
■ Terminal Arrangement/Internal Connections (Top View)

G3VM-353B/B1



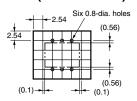
G3VM-353E/E1

G3VM-353E/E1



■ PCB Dimensions (Bottom View)

G3VM-353B/B1



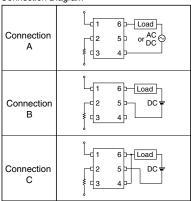
■ Actual Mounting Pad Dimensions (Recommended Value, Top View)

■ Absolute Maximum Ratings (Ta = 25°C)

Item			Symbol	Rating	Unit	Measurement Conditions		
Input LED forward current		I _F	50	mA				
	Repetitive peak LED forward current		I _{FP}	1	Α	100 μs pulses, 100 pps		
	LED forward current reduction rate		Δ I _F /°C	-0.5	mA/°C	$T_a \ge 25^{\circ}C$		
	LED reverse voltage		V_R	5	V			
	Connection temperature		T _j	125	°C			
Output	Load voltage (AC peak/DC)		V_{OFF}	350	V			
	Continuous load current (AC peak/DC)	Connection A	Io	150 (100)	mA			
		Connection B		150 (100)				
		Connection C		300 (200)				
	ON current reduction rate	Connection A	Δ I _{ON} /°C	-1.5 (-1)	mA/°C	$T_a \ge 25^{\circ}C$		
		Connection B		-1.5 (-1)				
		Connection C		-3.0 (-2)				
	Connection temperature		T _j	125	°C			
Dielectric strength between input and output (See note 1.)		V _{I-O}	2,500	V_{rms}	AC for 1 min			
Operating temperature		T _a	-40 to +85	°C	With no icing or condensation			
Storage temperature			T_{stg}	-55 to +125	°C	With no icing or condensation		
Soldering temperature (10 s)				260	°C	10 s		

 The dielectric strength between the input and output was checked by applying voltage be-tween all pins as a group on the LED side and all pins as a group on the light-receiving side. Note:

Connection Diagram



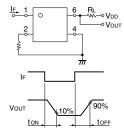
Values in parentheses are for the G3VM-353B1/E1.

■ Electrical Characteristics (Ta = 25°C)

ltem		Symbol	Mini- mum	Typical	Maxi- mum	Unit	Measurement conditions	
Input	t LED forward voltage		V _F	1.0	1.15	1.3	٧	I _F = 10 mA
	Reverse current		I _R			10	μΑ	V _R = 5 V
	Capacity between terminals Trigger LED forward current		Ст		30		pF	V = 0, f = 1 MHz
			I _{FT}		1	3	mA	I _{OFF} = 10 μA
Output	Maximum resistance with output ON	Connection A	R _{ON}		15 (27)	25 (50)	Ω	I _O = 150 mA (100 mA)
		Connection B			8 (20)	14 (43)	Ω	I _O = 150 mA (100 mA)
		Connection C			4 (10)	7 ()	Ω	I _O = 300 mA (200 mA)
	Current leakage when the relay is open		I _{LEAK}		0.0105 (0.003)	1.0	μА	I _F = 5 mA, V _{OFF} = 350 V
	Capacity between terminals A Connection		C _{OFF}		85 (30)		pF	$V = 0$, $f = 1MHz$, $I_F = 5 \text{ mA}$
Capacity between I/O terminals		C _{I-O}		0.8		pF	f = 1 MHz, Vs = 0 V	
Insulation resistance		R _{I-O}	1,000			ΜΩ	$V_{I-O} = 500 \text{ VDC},$ $R_{oH} \le 60\%$	
Turn-ON time		t _{ON}		0.1 (0.25)	1.0 (0.5)	ms	$I_F = 5 \text{ mA}, R_L = 200 \Omega,$	
Turn-OFF time		t _{OFF}		1.0 (0.5)	3.0 (1)	ms	V _{DD} = 20 V (See note 2.)	
Values i	n narentheses are for th	o G2V/M 252B1/I	<u> </u>			!		ļ.

Note:

2. Turn-ON and Turn-OFF Times



Values in parentheses are for the G3VM-353B1/E1.

■ Recommended Operating Conditions

Use the G3VM under the following conditions so that the Relay will operate properly.

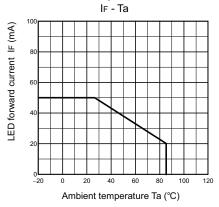
Item	Symbol	Minimum	Typical	Maximum	Unit
Load voltage (AC peak/DC)	V _{DD}			280	V
Operating LED forward current	I _F	5		25	mA
Continuous load current (AC peak/DC)	I _o			150 (100)	mA
Operating temperature	T _a	- 20		65	°C

Values in parentheses are for the G3VM-353B1/E1

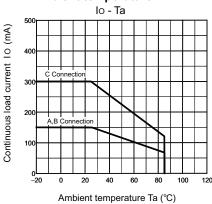
■ Engineering Data

G3VM-353B/E

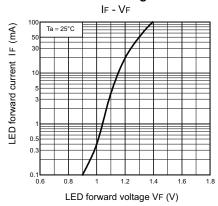
LED forward current vs. Ambient temperature



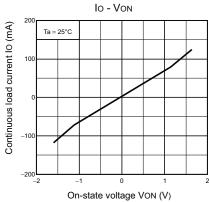
Continuous load current vs. Ambient temperature



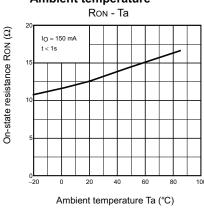
LED forward current vs. LED forward voltage



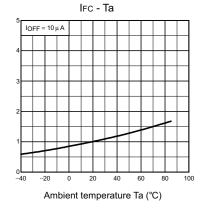
Continuous load current vs. On-state voltage



On-state resistance vs. Ambient temperature

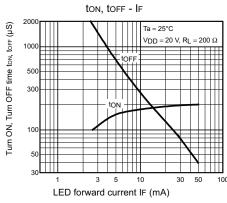


Trigger LED forward current vs. Ambient temperature

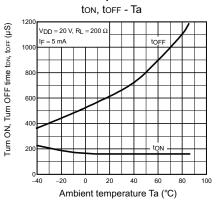


Trigger LED forward current IFC(mA)

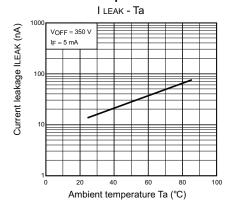
Turn ON, Turn OFF time vs. LED forward current



Turn ON, Turn OFF time vs. Ambient temperature

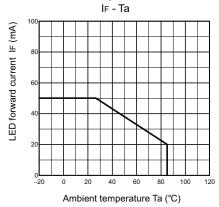


Current leakage vs. Ambient temperature

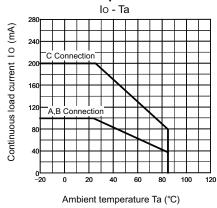


■ Engineering Data G3VM-353B1/E1

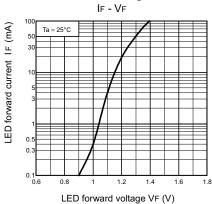
LED forward current vs. Ambient temperature



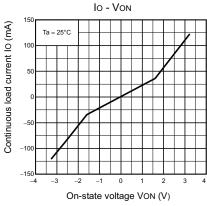
Continuous load current vs. Ambient temperature



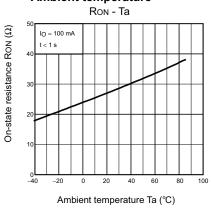
LED forward current vs. LED forward voltage



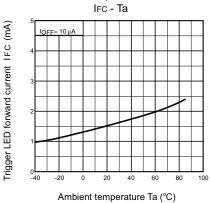
Continuous load current vs. On-state voltage



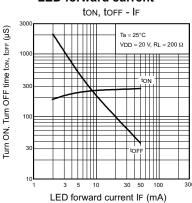
On-state resistance vs. Ambient temperature



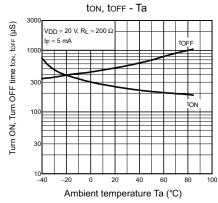
Trigger LED forward current vs. Ambient temperature



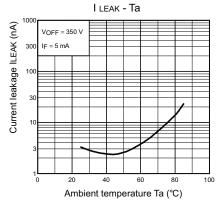
Turn ON, Turn OFF time vs. LED forward current

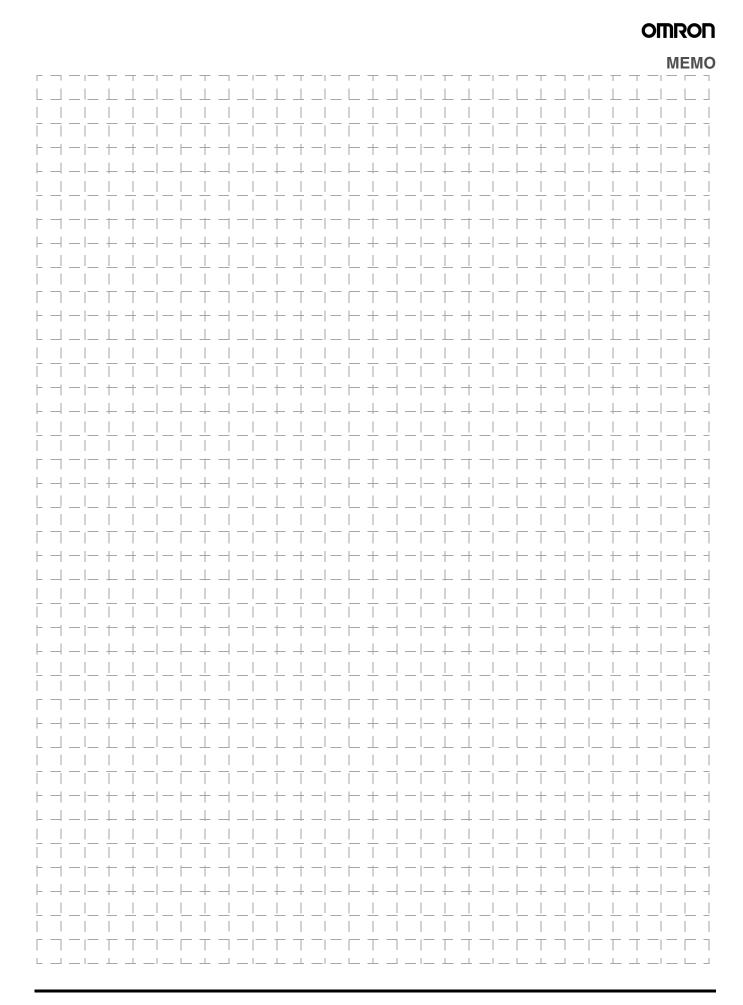


Turn ON, Turn OFF time vs. Ambient temperature



Current leakage vs. Ambient temperature







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